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(12) **United States Design Patent**
Frank et al.

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(54) **CPU BOARD ASSEMBLY PANEL**
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(US)
(73) Assignee: **Sun Microsystems, Inc.**, Palo Alto, CA
(US)
(**) Term: **14 Years**

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D428,892 S * 8/2000 Haimson D14/441

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(21) Appl. No.: **29/138,911**
(22) Filed: **Mar. 21, 2001**

(51) **LOC (7) Cl.** **14-02**
(52) **U.S. Cl.** **D14/441**
(58) **Field of Search** D14/441-446;
D13/162, 184, 199, 164, 177; 312/223.2;
361/680-686

(57) **CLAIM**

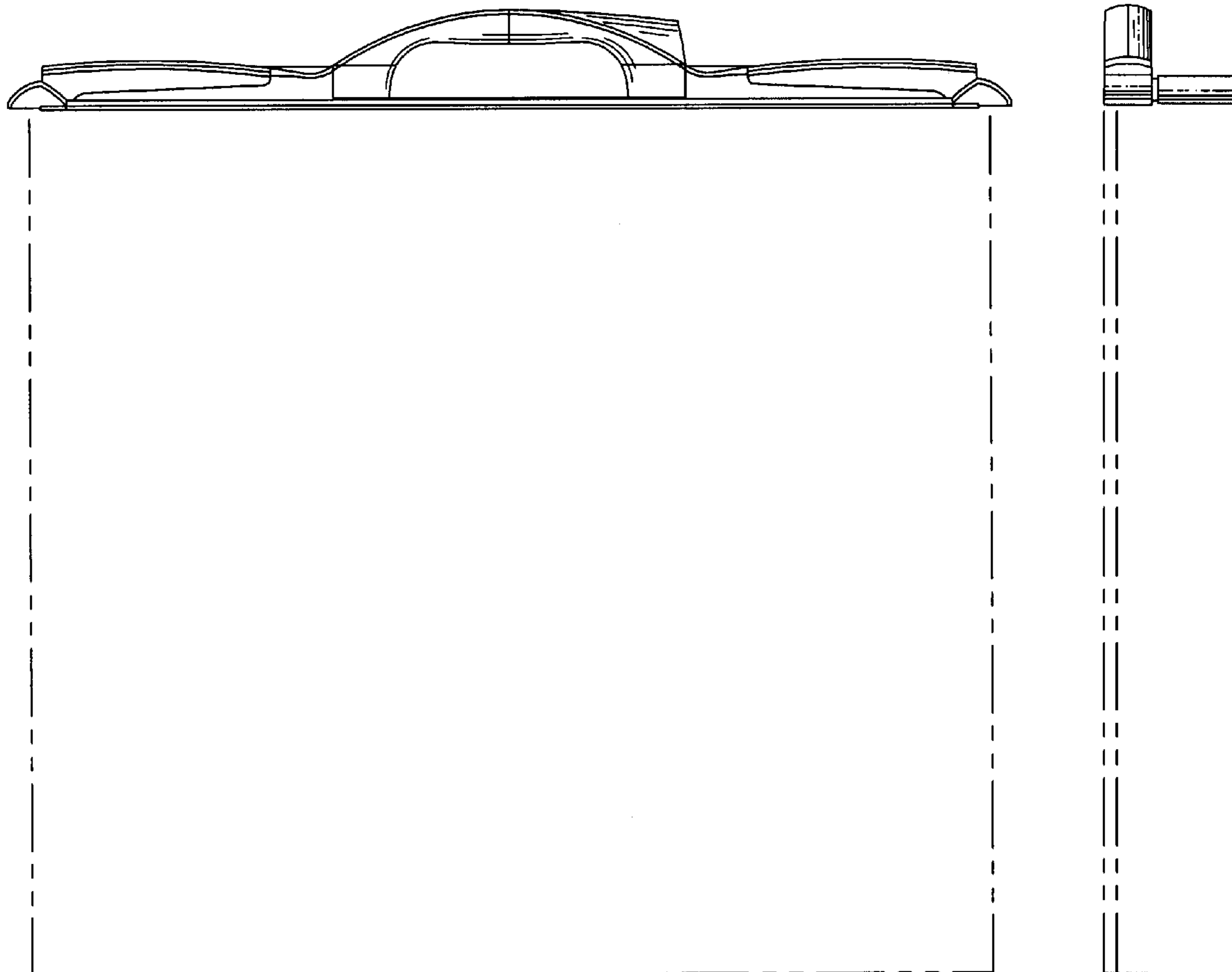
The ornamental design for CPU board assembly panel, as shown and described.

DESCRIPTION

FIG. 1 is a bottom view thereof;
FIG. 2 is a top view thereof;
FIG. 3 is a back elevational view thereof;
FIG. 4 is a left side elevational view thereof; and,
FIG. 5 is a right side elevational view thereof.
The broken lines are shown in the views for illustrative purposes only and form no part of the claimed design.

(56) **References Cited**
U.S. PATENT DOCUMENTS
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1 Claim, 2 Drawing Sheets



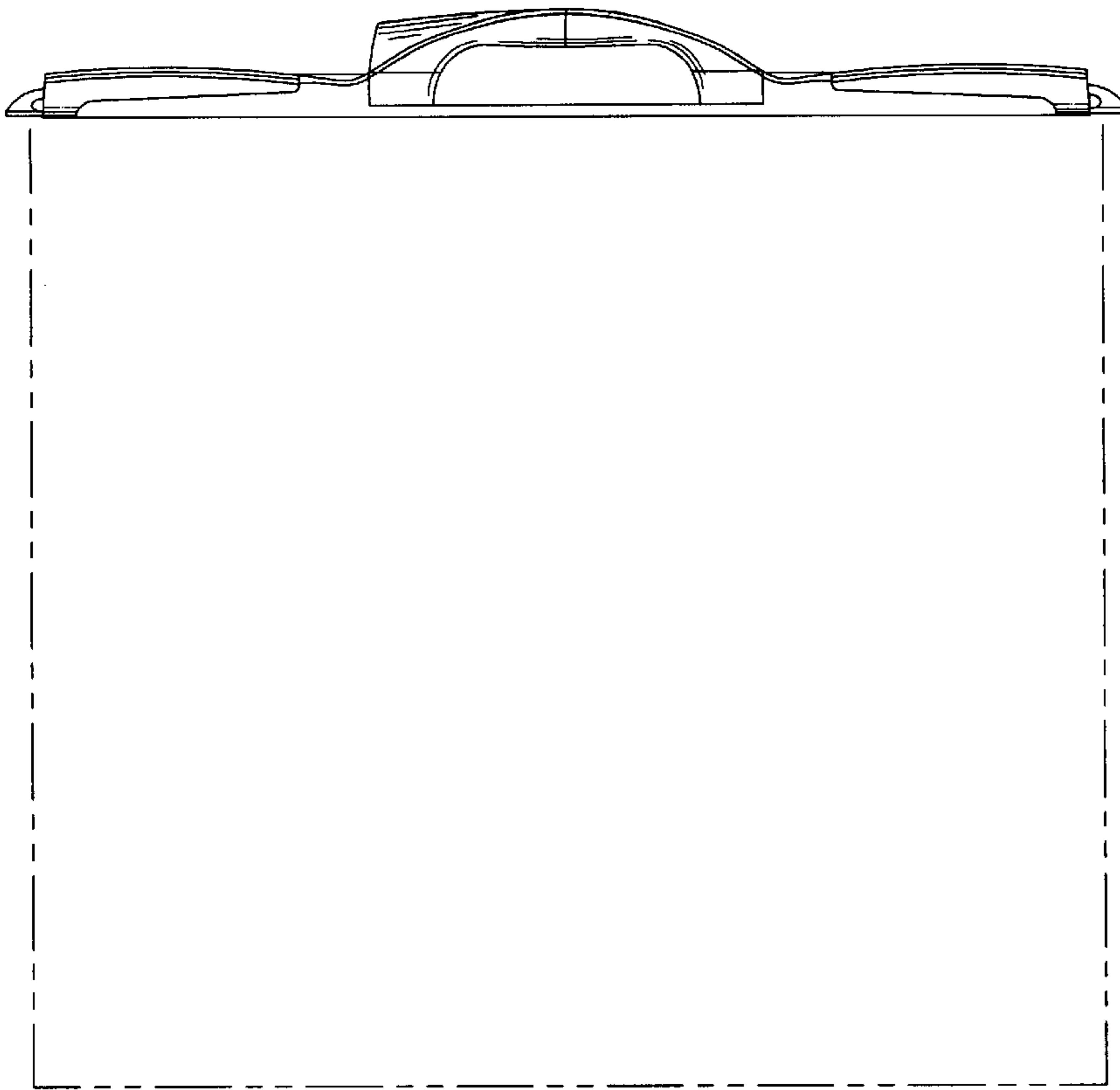


FIG. 1

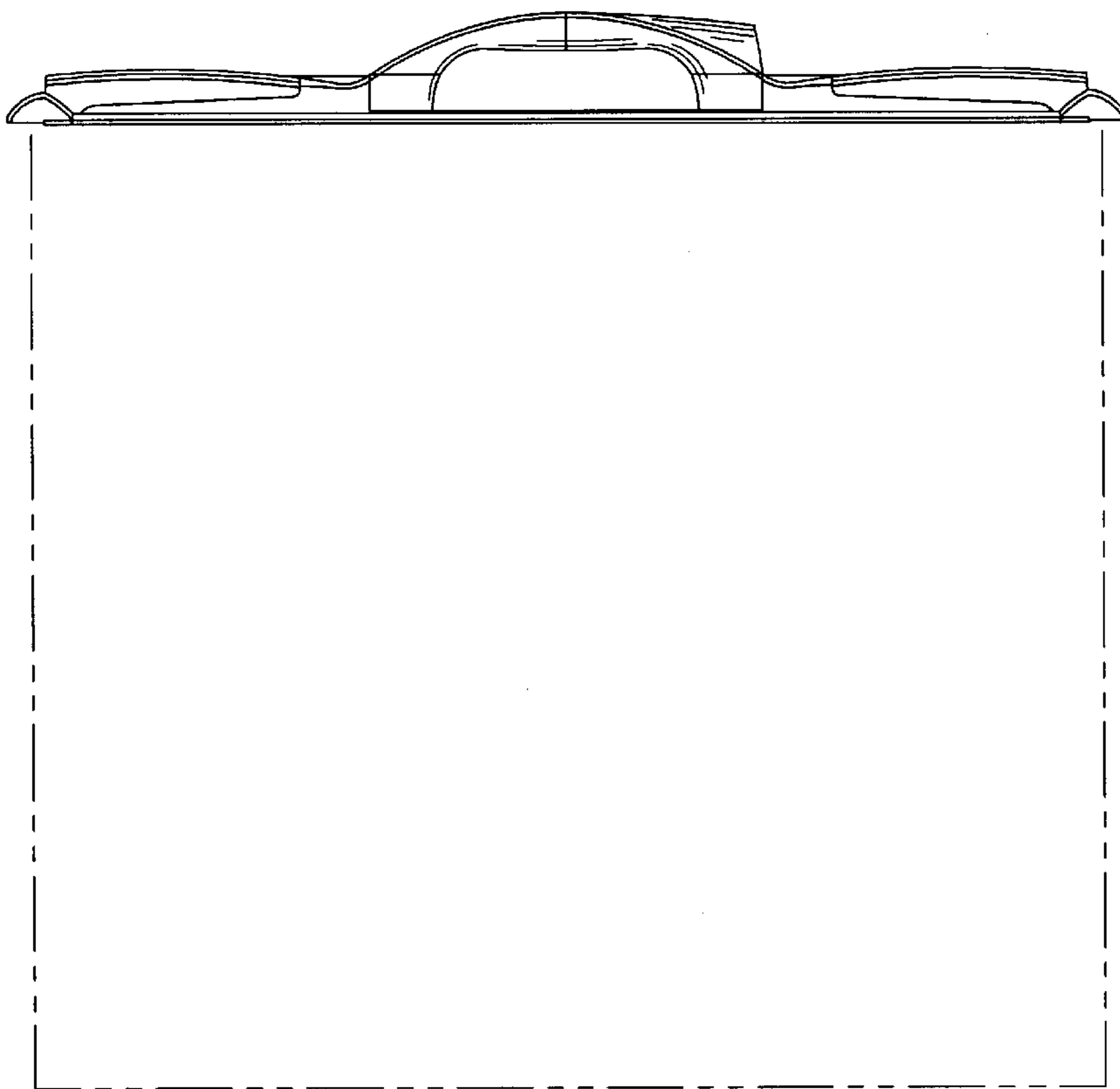


FIG. 2

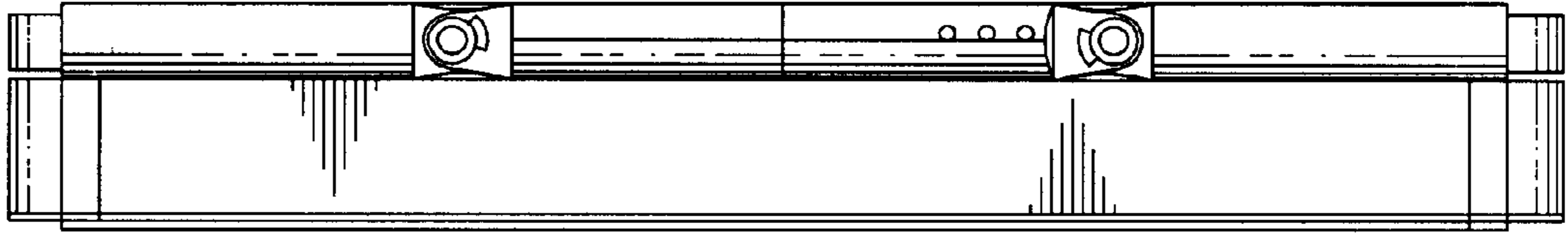


FIG. 3

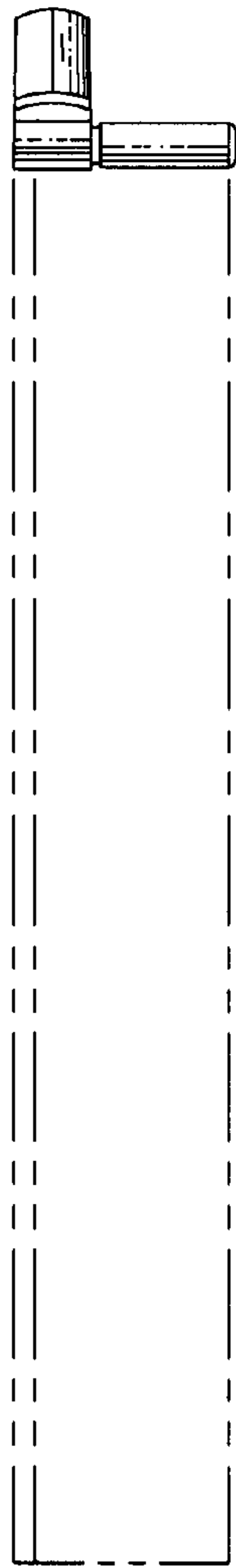


FIG. 4

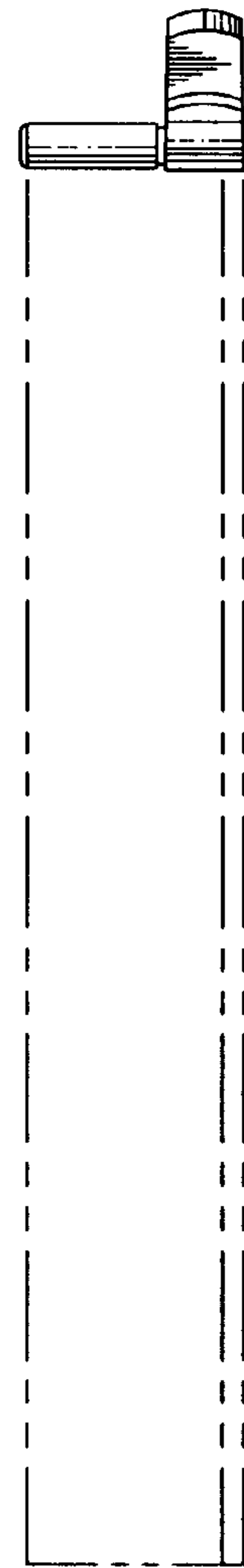


FIG. 5